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NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT			
CONVEYING PARTY D	ΑΤΑ					
		Name	Name			
YOUNGSEON LEE				11/24/2015		
CHANG GIL LEE				11/24/2015		
RECEIVING PARTY DA	TA					
Name:	KOREA INSTITUTE OF MACHINERY AND MATERIALS					
Street Address:	156 GAJEONGBUK-RO					
Internal Address:	YUSEONG-GU					
City:	DAEJEON					
State/Country:	KOREA	KOREA, REPUBLIC OF				
Postal Code:	305-343					
Property TypeApplication Number:1481		Number 14811223				
Application Number: 148		14811223				
CORRESPONDENCE D	ΑΤΑ					
Fax Number:(312)		(312)876-7934				
		the e-mail address first; if ; if that is unsuccessful, it				
		3128767925				
Email: Correspondent Name:		patents.us@dentons.com DENTONS US LLP				
•		P.O. BOX 061080				
Address Line 4:		CHICAGO, ILLINOIS 60606-	1080			
ATTORNEY DOCKET NUMBER:		10024243-000016	10024243-000016			
NAME OF SUBMITTER:		SUSAN FARLEY	SUSAN FARLEY			
SIGNATURE:		/susan farley/	/susan farley/			
DATE SIGNED:		11/30/2015	11/30/2015			
Total Attachments: 2 source=Executed Assignr		1				

ASSIGNMENT

FOR a valuable consideration, the sufficiency and receipt of which is hereby acknowledged, the undersigned

whose mailing address(es) is/are as listed below under their signature:

hereby sell(s), assign(s) and transfer(s) unto <u>Korea Institute of Machinery and Materials</u>, a corporation of <u>Republic of Korea</u>, having its principal office at 156, Gajeongbuk-Ro, Yuseong-Gu, Daejeon 305-343, Republic of Korea

the whole right, title and interest in and to a certain invention or improvement in

WORK HARDENABLE YIELD RATIO CONTROLLED STEEL AND METHOD OF MANUFACTURING THE SAME

disclosed in an application for Letters Patent of the United States, prepared by the firm of Dentons US LLP of Chicago, Illinois, and executed of even date herewith, said application being identified in the office records of said firm as Case No. <u>10024243-0016</u>, and in and to the United States Letters Patent therefor, when issued, together with all improvements thereon and betterments thereof, all divisions, continuations and reissues thereof and substitutions of or for said application, and all rights and privileges under the Letters Patent that may be granted therefor, including the right to claim the benefit of an earlier filing date for the same invention in a foreign country.

I/We hereby authorize and request the Commissioner of Patents to issue the Letters Patent that may be granted for said invention or improvements to said <u>Korea Institute of Machinery and Materials</u>

For the same consideration, I/we hereby agree that I/we will promptly communicate to the aforesaid assignee or its assigns full and complete information concerning said improvements or betterments of the inventions disclosed in said application, and will cooperate at any time upon request of said assignee or its assigns, at its expense, in the procurement of patent protection to cover the inventions herein assigned and to be assigned, including the execution of new, divisional, continuing and reissue applications; will make all rightful oaths, will testify in any proceedings in the United States Patent Office or in the Courts, and generally will do everything lawfully possible to aid said assignee, its successors, assigns and nominees to obtain, enjoy and enforce proper patent protection for the inventions embraced within the terms of this document.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: <u>14/811.223</u>, Filing Date: July 28, 2015.

DATE November 24 2015

Youngseon Lee 301-1501 Sungwon Apt., Sangnam-dong Seongsan-gu, Changwon-si, Gyeongsangnam-do, KR

DATE: Novemba-24,2015

Chang Gil Lee 106-2005, Privilege Apt., Sungju-dong Seongsan-gu, Changwon-si Gyeongsangnam-do, KR

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